

# Panasonic

NEW

3D Control

## FAYb Laser Marker

LP-M SERIES

**FDA**  
Conforming to  
FDA regulations

**CE**  
Conforming to  
Low voltage  
and EMC Directive



HIGH  
POWER

3D  
CONTROL

SAFETY



**FLINKENBERG**  
electronics

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# *Productivity and safety in one* *New 3D fiber laser marker LP-M series*

Since its release of fiber laser marker in 1999, constantly evolving Panasonic products have contributed to improve productivity. These days new safety standards are established and more strict safety measures are required, because manufacturing equipment powered by laser is widely spread. Safety functions included on the **LP-M** series comply with new safety standards. The **LP-M** series contributes to establish safer equipment design, in addition to improve productivity.

## HIGH POWER

The 40 W high-power laser enables deeper and faster marking and processing. Takt time reduction significantly improves productivity.



## 3D CONTROL

Mark based on the size or shape of a workpiece. Production lines are easy to design and stages can be changed smoothly.



FAYb Laser Marker  
***LP-M series***



Panasonic

LP-M series  
FAYB LASER MARKER



# SAFETY

Redundant safety measures for controlling the hazard source (laser beam) make it easier to improve safety level.



# HIGH POWER

Panasonic Industrial Devices SUNX's top-level 40 W high output FAYb laser marker marks or processes deeper and faster on metallic workpieces. Handles an expanded range of laser marker marking / processing applications.



Engine block [marking]



Connecting rod [marking]



Engine part [marking]



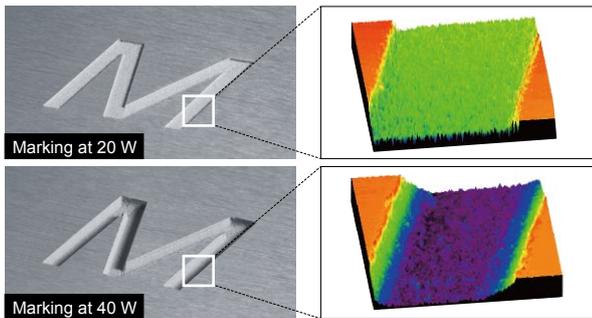
Gasket [coating removal]

# High power laser for deep engraving and high-speed marking

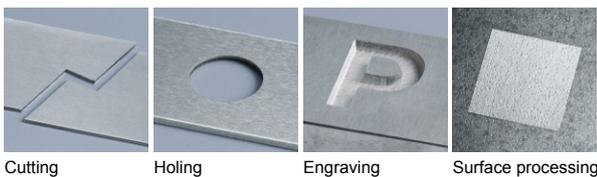
## Deep engraving marking / laser processing

Allows deeper and sharper marking and processing to handle demanding applications. No blade is used for high-quality, stable processing.

### Deep engraving sample [image]



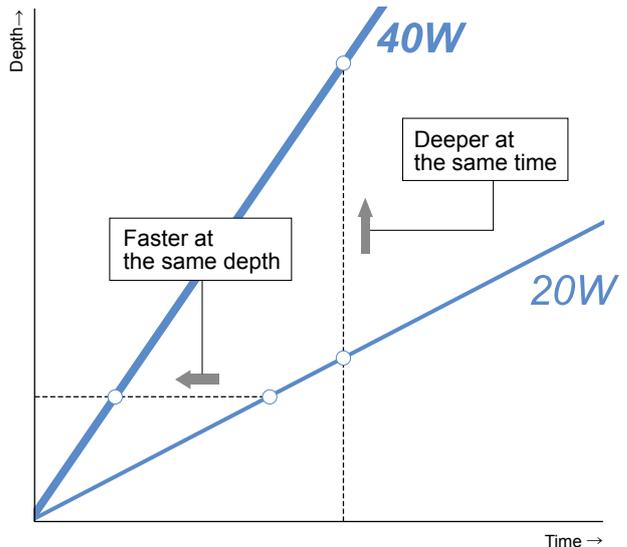
### Laser processing sample [image]



## High-speed marking

The larger the energy amount sent to the workpiece, the faster and deeper the marking / processing. Takt time reduction greatly enhances productivity.

### Image of high-speed deep engraving



## PLUS More Environmental resistance

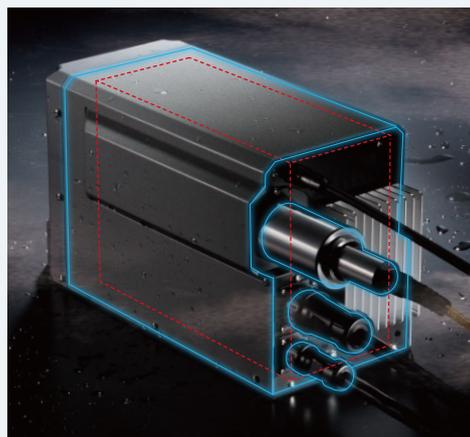
Durable protective structure is a benefit in harsh environments containing dust and water  
**IP64 fanless small head**

### Fanless small head

Significant improvements in radiation performance enabled a small and fanless head design which is capable of high output. Install with confidence, free from worry about fan clogs.

### IP64 Head Protective Design

Employs an inner and outer layer Double Protective Design for better airtightness inside the head. The complete air tight seal prevents dust and water entering from any direction for stable operation on the production floor.



### What is IP?

IP indicates the degree of protection from water, the human body, or solid foreign objects, based on IEC / JIS standards.

Dust does not enter the interior. (Completely prevented)

**IP 6 4**

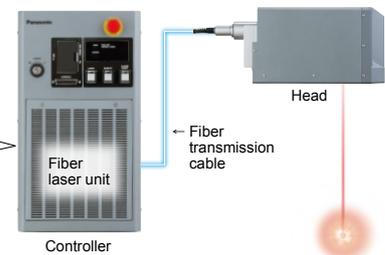
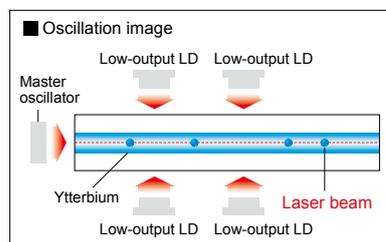
Does not receive adverse effects from water spray from any direction.

\*Anti-dust / waterproof design as per conditions stipulated in IEC / JIS standards. \*Parts must be attached correctly to realize the FAYb laser environmental resistance properties.

### Principles and features of FAYb laser oscillation

In a revolutionary method, the FAYb laser amplifies a weak laser beam from a master oscillator as it passes through a fiber treated with the element Ytterbium to emit a strong laser beam. Conversion loss is minimal as the FAYb laser amplifies laser beams in the fiber and achieves an excellent beam-to-beam conversion efficiency of approximately 50%. Power consumption is minimized despite high output and contributes to reduced carbon footprint.

Weak pulse laser beams are amplified by absorbing low-output LD beams as they pass through the fiber.





# 3D CONTROL

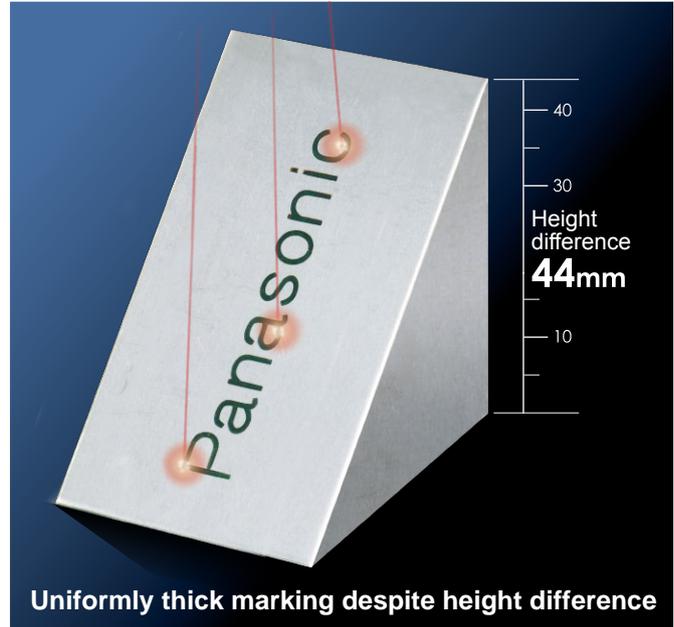
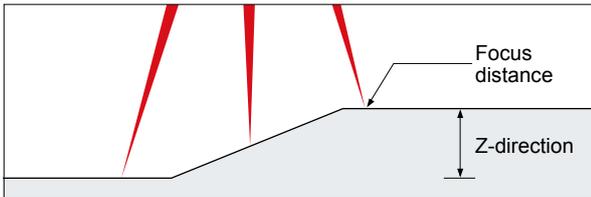
3D Control capability allows marking on various types of products and complicated shapes to meet a large number of application needs. Enables the best marking on every product type. The LP-M series contributes to production efficiencies, equipment miniaturization and reduced costs.

# Optimum marking quality on every workpiece

## High performance Z-axis stroke mechanism

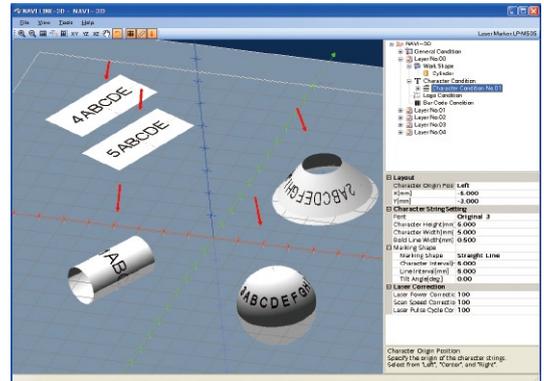
The Z-axis stroke mechanism controls the laser beam focal point in the Z-direction to enable marking on an item with height differences. Marks clearly with no distortion on slanted, curved and stepped surface shapes. Spot average marking enables control of the laser beam spot diameter for uniform marking thickness and depth.

### Variable control of focus distance via Z-axis stroke



## Simple 3D settings: NAVI LINK-3D Optional

Easy-to-use software enables you to create marking data by simply overlapping a workpiece shape with the characters and shape data to mark. Check the workpiece from any angle on the image screen to make simple adjustments. For use in overseas factories, English is also available in addition to Japanese.



## PLUS More Marking stability features



Use the displacement sensor for the best marking on every piece

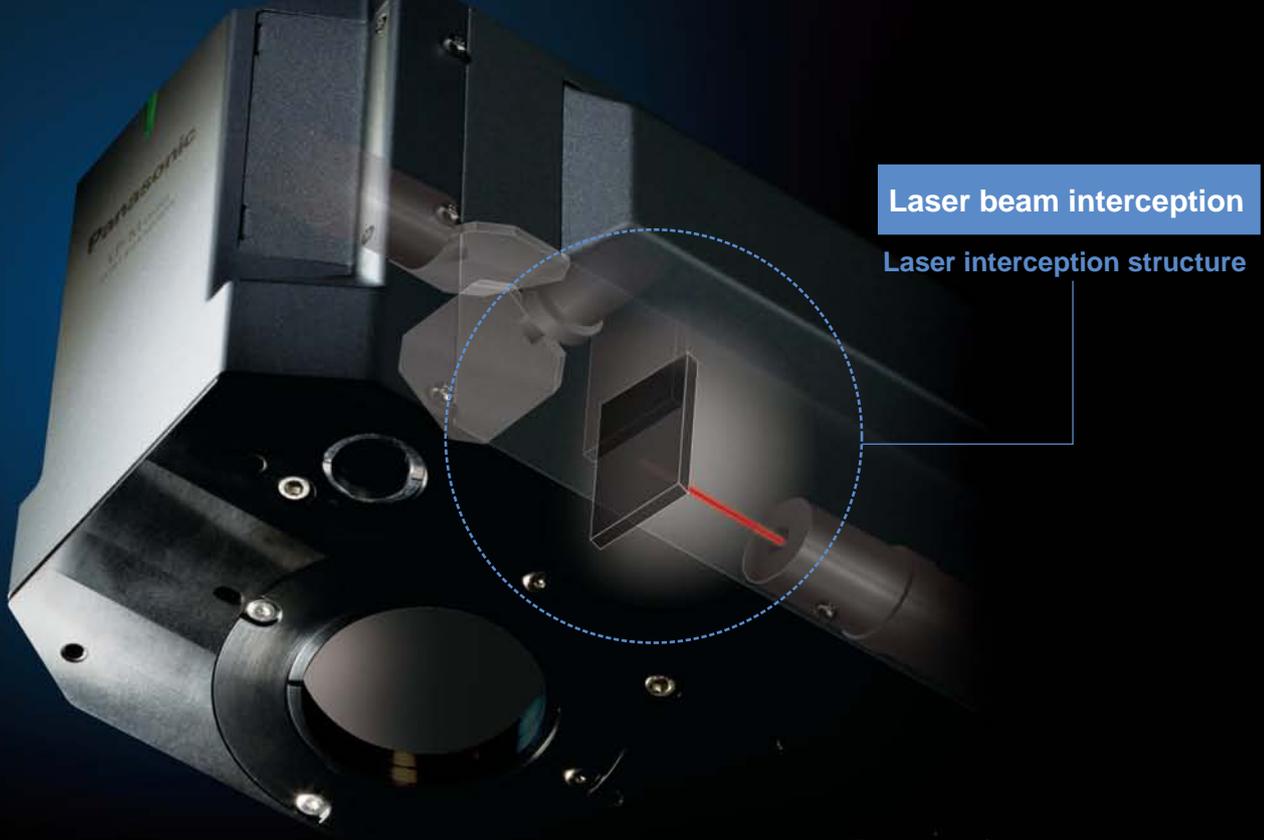
### Displacement input

Varying workpiece heights during production causes discrepancies in printing quality. The LP-M series can measure workpiece height data directly with the displacement sensor. All workpiece heights can be checked before marking for stable production quality.

■ Sample marked at a position 2mm away from the correct height



NEW



**Laser beam interception**

Laser interception structure

\*The laser beam is for illustration purposes.  
An intercepted laser beam is not reflected.

# SAFETY

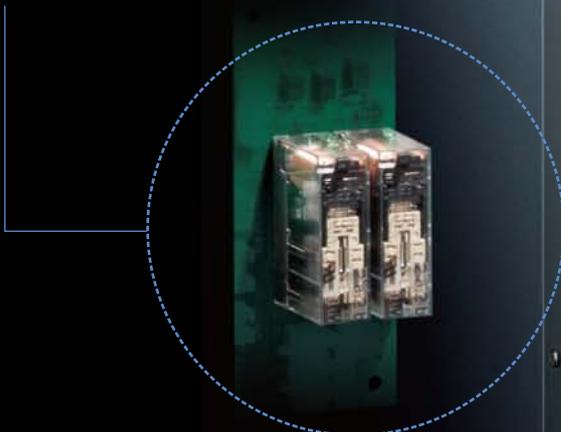
Concern for machine safety has increased as globalization progresses.

A way to safely intercept or stop the laser beam, which is a hazard source in a laser device, is essential.  
(Compliant with international standard ISO 11553-1)

Two newly mounted safety mechanisms improve both Productivity and Safety.

**Stopping the laser power source**

Duplicate interlock circuits

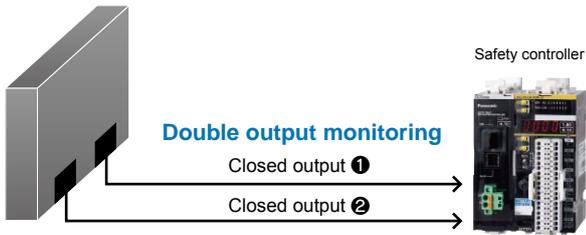


# Two new functions simplify safe circuit design

## Laser interceptor [-S type only] NEW

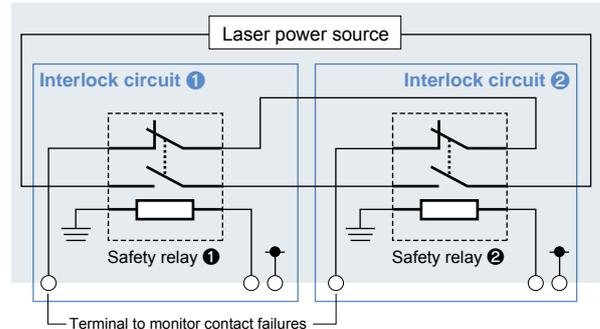
Durability has vastly improved since the first laser interceptor developed. Two outputs can be monitored to check laser interception. Safety is ensured even when the laser power source is on, preventing productivity losses.

### Laser interception image



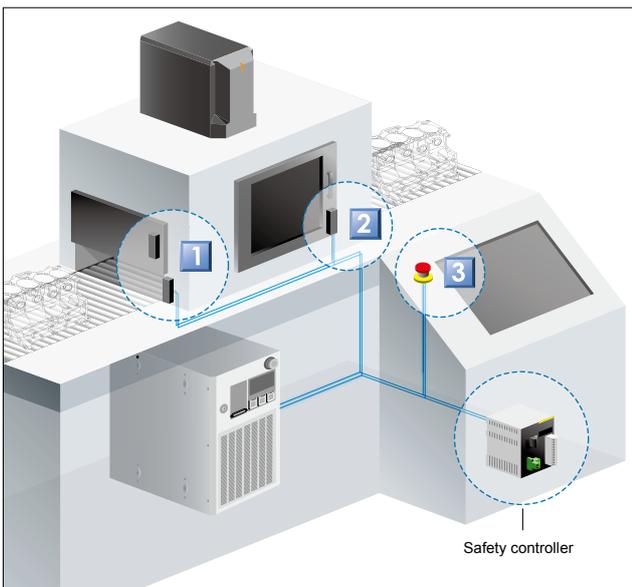
## Duplicate interlock circuits NEW

Mounted with 2 interlock circuits instead of one. A safety relay is also deployed to ensure the laser power source is stopped.



## Safety control system structure

International standard ISO 13849-1 (JIS B 9705-1) regulates safety function of safety-related parts of control systems, and requires safeguards be taken for an entire system embedded with a laser marker.



### 1 Safeguards for the shutter where workpiece is loaded / unloaded

#### Safe structure with Laser Intercept Feature

Each time a workpiece is loaded or unloaded, the shutter opens and closes. When the shutter is open, the laser intercept mechanism closes to ensure safety. Impacts on production efficiency during mass production are avoided because the laser power source does not need to be stopped each time it opens or closes.

[Operation safety device] Safety magnetic switch, etc.

### 2 Safeguards for Maintenance Shutter

#### Safe structure with Laser Intercept Feature

The shutter opens and closes during maintenance or fine tuning. When the shutter is open, the laser intercept mechanism closes to ensure safety. Work efficiency during mass production is not lost because the laser power source does not need to be stopped each time it opens or closes.

[Operation safety device] Safety door switch, etc.

### 3 Safeguards for Emergencies

#### Safe structure with Interlock Circuits

In an emergency, forces the laser power source (hazard source) to stop.

[Operation safety device] Emergency stop switch

## PLUS More Useful, reassuring features to prevent accidents

### Reassuring features used in production

#### ■ Mark energy measurement

Measures the power when marking, when outside a set range, uses error output to notify.

#### ■ Broken line notification

Stops laser immediately if a severed fiber line is detected.

#### ■ Erroneous irradiation detection

Stops laser immediately if unforeseen laser irradiation is detected.

#### ■ Emergency stop switch

Also equipped to the laser marker controller. Can be stopped individually.

### Convenient safety inspection functions

#### ■ Laser output measurement

Measures the current laser output.

#### ■ Laser output check

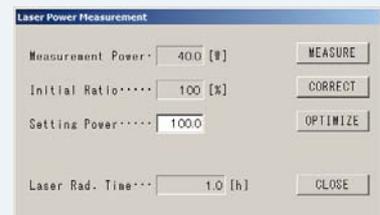
Monitor laser output attenuation from the time of purchase.

#### ■ Laser output correction

Calibrate with a commercially available power meter.

#### ■ Error history view

Displays error time, date and details.





# Specifications

Model No.	LP-M500				LP-M200				
	LP-M500	LP-M500-S	LP-M505	LP-M505-S	LP-M200	LP-M200-S	LP-M205	LP-M205-S	
Work distance	190 ± 22 mm 7.480 ± 0.866 in		220 ± 22 mm 8.661 ± 0.866 in		190 ± 22 mm 7.48 ± 0.866 in		220 ± 22 mm 8.661 ± 0.866 in		
Marking range	120 × 120 mm 4.724 × 4.724 in		220 × 220 mm 8.661 × 8.661 in		120 × 120 mm 4.724 × 4.724 in		220 × 220 mm 8.661 × 8.661 in		
Marking laser	Class 4 Yb fiber laser; λ = 1,064 nm 0.0419 mil laser								
	Average output*1	40 W ± 5 % (pulse oscillation)				16 W ± 5 % (pulse oscillation)			
Guide laser / pointer	Red semiconductor laser; λ = 655 nm 0.026 mil; Class 2 laser: Maximum output 1 mW or less								
Scanning method	X-, Y- and Z-axis directions; 3D scanning method								
Scan speed	Maximum 12,000 mm/sec. 472.441 in/sec.								
Character settings (character height, width)	0.1 to 120 mm 0.004 to 4.724 in (configurable in 0.001 mm 0.0004 in steps)		0.1 to 220 mm 0.004 to 8.661 in (configurable in 0.001 mm 0.0004 in steps)		0.1 to 120 mm 0.004 to 4.724 in (configurable in 0.001 mm 0.0004 in steps)		0.1 to 220 mm 0.004 to 8.661 in (configurable in 0.001 mm 0.0004 in steps)		
Setting range (linear, proportional, monospaced)	Character spacing	0 to 120 mm 0 to 4.724 in		0 to 220 mm 0 to 8.661 in		0 to 120 mm 0 to 4.724 in		0 to 220 mm 0 to 8.661 in	
	Line pitch	0 to 999.999 mm 0 to 39.370 in (configurable in 0.001 mm 0.0004 in steps)							
Setting range (arced)	Radius	0 to 999.999 mm 0 to 39.370 in (configurable in 0.001 mm 0.0004 in steps)							
	Angle	-180° to +180° (configurable in 0.01° steps)							
	Line pitch radius	0 to 120 mm 0 to 4.724 in (configurable in 0.001 mm 0.0004 in steps)		0 to 220 mm 0 to 8.661 in (configurable in 0.001 mm 0.0004 in steps)		0 to 120 mm 0 to 4.724 in (configurable in 0.001 mm 0.0004 in steps)		0 to 220 mm 0 to 8.661 in (configurable in 0.001 mm 0.0004 in steps)	
Logo data	VEC*2, DXF, BMP, HPGL, JPEG, AI, EPS								
Marking shape	Linear, proportional, monospaced, arced								
Character types	English uppercase letters, English lowercase letters, numerals, katakana, hiragana, kanji (JIS No. 1 and No. 2 standards), symbols, user-registered characters (up to 50)								
Barcodes	Code 39, Code 128, ITF, NW-7, JAN / UPC, RSS-14 (GS1 DataBar), RSS (GS1 DataBar) Limited, RSS (GS1 DataBar) Expanded								
2D codes	QR Code, Micro QR Code, Data Matrix, GS1 Data Matrix								
Composite codes	RSS-14 (GS1 DataBar) CC-A, RSS (GS1 DataBar) Limited CC-A, RSS (GS1 DataBar) Expanded CC-A, UCC / EAN COMPOSITE, etc.								
I/O	Input terminal, Output terminal, I/O connector								
Interface	VGA port, USB connector A, I/O input and output, RS-232C, Ethernet, Input-output terminal, INTERLOCK*3, displacement sensor, laser gate I/O (-S type only)								
Displacement sensor input	Analog current input (4 to 20 mA)								
Cooling method	Head: Naturally air cooling, Controller: Forced air cooling								
Power supply	90 to 132 V AC, or 180 to 264 V AC, 50 / 60 Hz (Auto-switching)								
Power consumption	580 VA or less (100 V AC), 720 VA or less (200 V AC)				390 VA or less (100 V AC), 510 VA or less (200 V AC)				
Laser gate	Not equipped	Equipped in Head	Not equipped	Equipped in Head	Not equipped	Equipped in Head	Not equipped	Equipped in Head	
Ambient temperature	0 to +40 °C +32 to +104 °F (Controller, Head) (No dew condensation or icing allowed)								
Ambient temperature for storage	-10 to +60 °C +14 to +140 °F (Controller, Head) (No dew condensation or icing allowed)								
Ambient humidity	35 % to 85 % RH (Controller, Head) (No dew condensation or icing allowed)								
Protective structure	IP64*4								
Net weight	Head	12 kg							
	Controller	28 kg							
Supported OS	Laser Marker Utility*5	Microsoft Windows® 7 Professional (32 bit / 64 bit) / Sp1 Vista Business (32 bit) SP2 / XP Professional (32 bit) SP3							
	NAVILINK-3D*6 (sold separately)	Microsoft Windows® 7 Professional (32 bit / 64 bit) / Sp1 Vista Business (32 bit) SP2 / XP Professional (32 bit) SP3							

\*1 Output at product processing edge (at configured power of 100, standard factory settings).

\*2 File format (logo file) that can be used by the laser marker.

\*3 Use a dry contact to connect the INTERLOCK 1 PIN-3 PIN. Deposition on the internal relay contact point can be monitored using INTERLOCK 1-2 PIN and INTERLOCK 2-2 PIN. When 1 PIN-3 PIN is closed, 2 PIN-2 PIN opens.

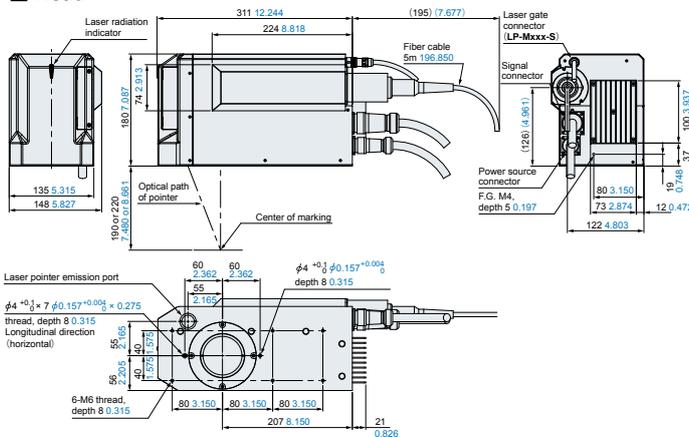
\*4 The head is IP64 only in regions where an electrical or optical part is deployed.

\*5 To use Export Vec, Adobe® Illustrator® Japanese language Ver. 9/10/CS - CS5 (Japanese OS only), English language CS3 - CS5 (English OS only), or Simplified Chinese CS5 (Simplified Chinese OS only) must be installed. Windows® 7 Professional, Vista Business, and XP Professional are trademarks or registered trademarks of Microsoft Corporation in the United State and other countries.

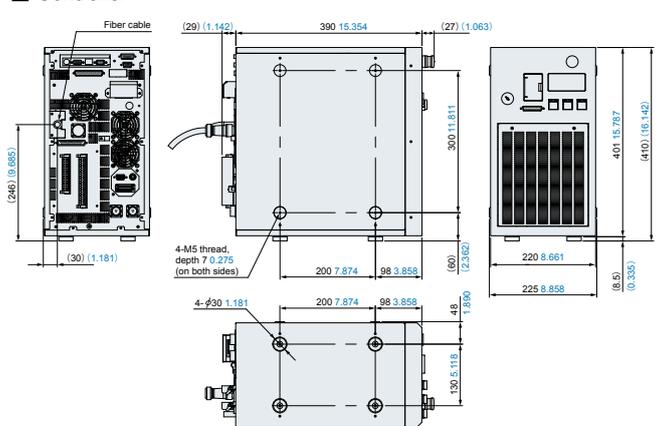
## Dimensions [Unit: mm in]

\*The CAD data in the dimensions can be downloaded from our Website.

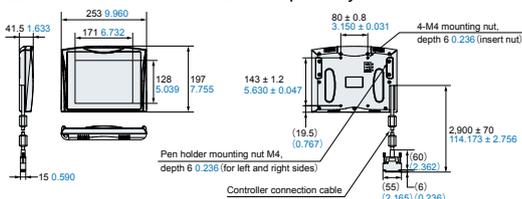
### Head



### Controller



### Console LP-ADP40 [sold separately]



## Precautions for Proper Use

### Laser safety

- This product is classified as a Class 4 Laser Product in IEC/JIS/FDA regulations 21 CFR 1040.10 and 1040.11. Never look at or touch the direct laser beam and its reflection.
- The following labels are attached to the **LP-M500** series. Handle the product according to the instruction given on the warning labels.  
(Warning labels are not shown in the product photographs in this catalog.)
- The laser used by this product generates infrared light that is invisible to the human eye. Use particular caution when the laser is operating.

### Maintenance

- Air filter:** Regularly clean the air filter attached to the FAYb Laser Marker to maintain cooling effects.
- Laser pointer emission port:** Dust or chips adhering to the laser pointer emission port may affect the printing quality or seriously damage the laser marker. Clean the laser pointer emission port regularly.

### Recommended use of a dust collector

- Depending on the object being marked, harmful gasses or smoke that have a detrimental effect on the human body or the laser marker may be generating during marking. If your application falls under this description, use a dust collector.

\*For more information, contact your sales representative.

**可視及び不可視レーザー放射**  
ビームや散乱光の目又は皮膚への被ばくを避けること  
注: ここを開くとクラス4の可視及び不可視レーザー放射が出るビームや散乱光の目又は皮膚への被ばくを避けること

**可視及び不可視レーザー放射の出口**  
被ばく回避のこと - この開口から可視及び不可視レーザー放射が出る

**VISIBLE AND INVISIBLE LASER RADIATION**  
AVOID EYE OR SKIN EXPOSURE TO DIRECT OR SCATTERED RADIATION  
CAUTION - CLASS 4 VISIBLE AND INVISIBLE LASER RADIATION WHEN OPEN. AVOID EYE OR SKIN EXPOSURE TO DIRECT OR SCATTERED RADIATION.

**可視及不可見激光辐射**  
目視或皮肤直接接触激光的直射光或反射光有危险! 不要目视或接触激光  
注意 - 打开此处时有4类可见及不可见激光辐射 目视或皮肤直接接触激光的直射光或反射光有危险! 不要目视或接触激光

**可視及不可見激光辐射**  
回避这里避免被照射 - 从此处开口有可见及不可見激光辐射

## Laser Marker Lineup

A full series for every application.

### High-power output & Environmental resistance

FAYb Laser Marker

## LP-S SERIES

The 42 W high-power output enables high-speed deep engraving. Combining IP67G and detachable fiber offers simplified installation in harsh environments.



Camshafts



Engine valves

### Short pulse laser marker for clear high contrast marking on resin surfaces

FAYb Laser Marker

## LP-V SERIES

Enables beautiful high contrast marking on resin surfaces by fully utilizing the characteristics of short pulse laser beams with minimal thermal influence.



IC



Resin molded products

### Fast, high-stability, high grade laser markers with advanced functions

CO2 Laser Marker

## LP-400 SERIES

Mark on resin, glass, paper, and a wide range of other materials. The high-power, high-performance image scanner delivers exceptional marking quickly and accurately.



Laser label (marking and half-cut)



Printed circuit board

2013.11

panasonic-electric-works.com

No. CE -LPM -5 November, 2013

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electronics

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